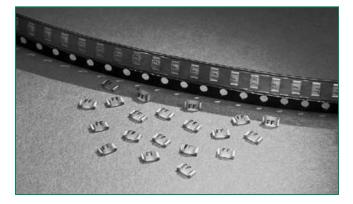
RoHS M HF 429 Series Fuse





Agency Approvals			
AGENCY	AGENCY FILE NUMBER	AMPERE RANGE	
91	E10480	7A	
SP	LR29862	7A	

Electrical Characteristics for Series

Electrical Specifications by Item

% of Ampere Rating	OpeningTime at 25°C
100%	4 hours, Minimum
200%	5 sec., Maximum
300%	0.2 sec., Maximum

Description

The 429 Series Fast-Acting SMF is a small (1206 size) thinfilm device designed for secondary protection of circuits used in space constrained applications such as hand-held portable electronic devices.

This series is Halogen-Free, Lead-Free and meets the requirements of the RoHS directive.

Features

- RoHS compliant and Lead-Free 7A device available-add 'L' suffix to part number.
- For new designs up to 5A please consult the 433 or 466 Series
- Halogen-Free 7A device available-add 'HF' suffix to the part number

Applications

Secondary protection for space constrained applications such as:

- Cell phones
- Battery packs
- Digital cameras
- DVD players
- Hard disk drives.

Ampere Rating (A)	Amp Code	Max Voltage Rating (V)	Interrupting Rating	Nominal Cold Resistance (Ohms)	Nominal Melting I²t (A²sec)	Age Appr	ency ovals
7.00	007.	24	35 amperes @ voltage, VAC/VDC	0.00925	3.6000	х	x

1. Measured at 10% of rated current, 25°C.

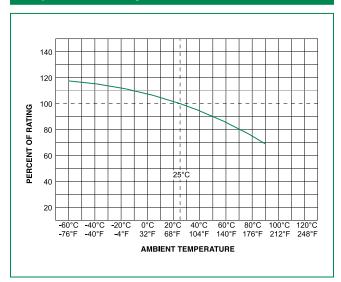
2. Measured at rated voltage.

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Temperature Rerating Curve

Average Time Current Curves



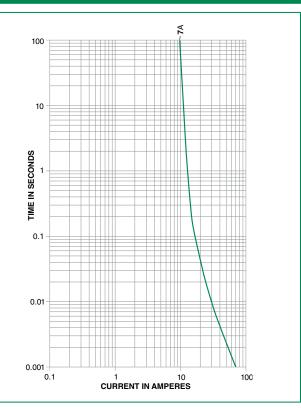
Note:

1. Derating depicted in this curve is in addition to the standard derating of 25% for continuous operation.

Example:

For continuous operation at 70 degrees celsius, the fuse should be derated as follows: I = (0.75)(0.90)I = -(0.90)I

 $I = (0.75)(0.80)I_{_{RAT}} = (0.60)I_{_{RAT}}$

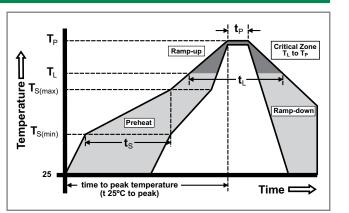


Soldering Parameters

Reflow Condition		Pb – Free assembly	
	-Temperature Min (T _{s(min)})	150°C	
Pre Heat	-Temperature Max (T _{s(max)})	200°C	
	-Time (Min to Max) (t _s)	60 – 180 secs	
Average ramp up rate (Liquidus Temp (T_{L}) to peak		5°C/second max	
T _{S(max)} to T _L - Ramp-up Rate		5°C/second max	
Reflow	-Temperature (T _L) (Liquidus)	217°C	
	-Temperature (t _L)	60 – 150 seconds	
Peak Temperature (T _P)		250 ^{+0/-5} °C	
Time within 5°C of actual peak Temperature (t _p)		20 – 40 seconds	
Ramp-down Rate		5°C/second max	
Time 25°C to peak Temperature (T _P)		8 minutes Max.	
Do not exceed		260°C	

Wave Soldering

260°C, 10 seconds max.





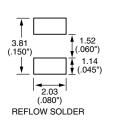
Product Characteristics

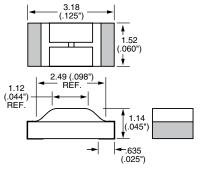
Materials	Body: Epoxy Substrate Terminations, RoHS Compliant Device (429L): 100% Tin over Nickel over Copper Element Cover Coat: Conformal Coating NOTE: Do not use alcohol-based cleaners or solvents with 429 Series Thin-Film Fuses as it may damage the coating.
Operating Temperature	– 55°C to 90°C. Consult temperature rerating chart. For operation above 90°C contact Littelfuse.
Thermal Shock	Withstands 5 cycles of – 55°C to 125°C

Humidity	MIL-STD-202F, Method 103B Condition D		
Vibration	Withstands 10 – 55 Hz per MIL-STD- 202F, Method 201A and 10-2000 Hz at 20 G's per MIL-STD-202F, Method 204D, Condition D.		
Insulation Resistance (After Opening)	Greater than 10,000 ohms		
Resistance to Soldering Heat	MIL-STD-202G, Method 210F, Condition D		

Dimensions

RECOMMENDED PAD LAYOUTS



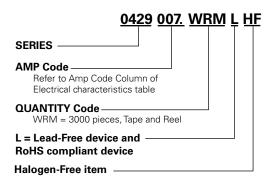


Part Marking System		
Series	Marking Code	

429L

Part Numbering System

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Packaging			
Packaging Option	Packaging Specification	Quantity	Quantity & Packaging Code
Tape & Reel – 8mm tape	EIA RS-481-1 (IEC 286, part 3)	3000	WRM